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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:

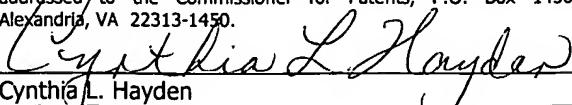
Leonard C. Pipes et al. § Art Unit: 2812
Serial No.: 10/764,751 § Examiner: Stanetta D. Isaac
Filed: January 26, 2004 § Atty Docket: ITL.0851D1US
For: Implanting Ions in Shallow § P15016D
Trench Isolation Structures § Assignee: Intel Corporation

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REPLY TO PAPER NO. 0305

Sir:

In response to the office action mailed March 25, 2005, please amend the above-referenced patent application as follows:

Date of Deposit: <u>May 26, 2005</u>
I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.
 Cynthia L. Hayden